



Premstätten, August 29, 2017

Process Change Notification 22-2017

Dear Customer,

Our manufacturer LAPIS Semiconductor is establishing new assembling and testing lines in ROHM Integrated Systems Thailand Co., Ltd. (abbr. RIST) for the stable supply of the products.

The reason of this re-alternation are as follows:

- To avoid the supply risk for outsourcing
- To avoid the influence for restructuring at outsourcing
- There is no postponement for shutdown at outsourcing

Affected products:

- Order Code: TDC-GPX; Our material number: 501880002
- Order Code: TDC-GPX SELECTED G; Our material number: 501880003

Applied technical change

Find detailed technical information of the changes in attachment **MSM99Q037-002T3-K-MT** from LAPIS Semiconductor Co., Ltd:

Technical changes:

Changes	Page
Assy and Test site	8
Man for Assy and Test	8
Material for Assy	8
Package code	8
Leadframe	10
Plating	10
Layout	10
Outline drawing Rist – LAPIS Semi Miyazaki	12, 13



Production Effectivity Change

1st October, 2017

We will of course continue to support already placed orders for current version and would like to give you the possibility to place your last time buy orders until 1st of February 2018.

Last shipment for current version: as per individual order confirmation

Impact on Product

No impact on product performance and manufacturing is anticipated.

Sample Availability

We will provide samples on demand.

Best Regards,

A handwritten signature in black ink, appearing to read 'D. Gleispach'.

Dietmar Gleispach
ams AG
Director Operations Division ISS